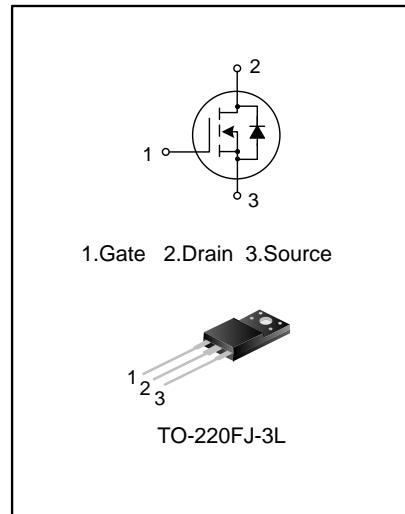


## 11A, 650V N-CHANNEL MOSFET

### GENERAL DESCRIPTION

The SVF11N65VFJ is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ high-voltage planar VDMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

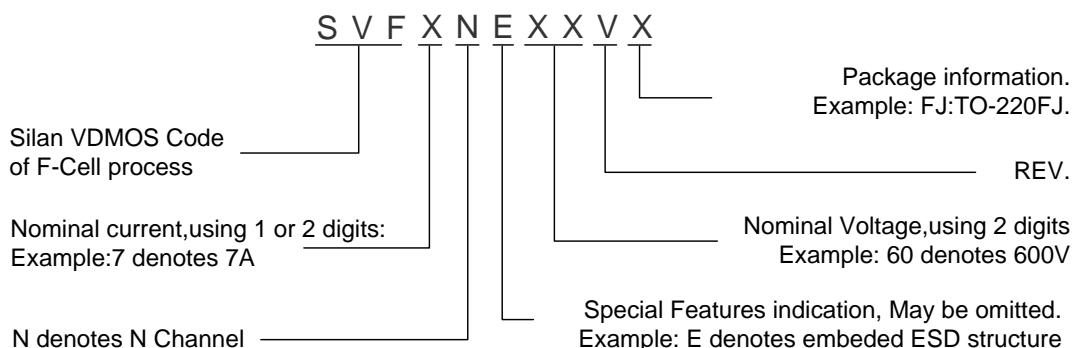
These devices are widely used in AC-DC power supplies, DC-DC converters and H-bridge PWM motor drivers.



### FEATURES

- 11A, 650V,  $R_{DS(on)(typ.)} = 0.6\Omega @ V_{GS}=10V$
- Low gate charge
- Low Crss
- Fast switching
- Improved dv/dt capability

### NOMENCLATURE



### ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing
SVF11N65VFJ	TO-220FJ-3L	11N65VFJ	Halogen free	Tube



## ABSOLUTE MAXIMUM RATINGS ( $T_c=25^\circ\text{C}$ , unless otherwise noted)

Characteristics		Symbol	Ratings	Unit
Drain-Source Voltage		$V_{DS}$	650	V
Gate-Source Voltage		$V_{GS}$	$\pm 30$	V
Drain Current	$T_c=25^\circ\text{C}$	$I_D$	11	A
	$T_c=100^\circ\text{C}$		7.0	
Drain Current Pulsed		$I_{DM}$	44	A
Power Dissipation( $T_c=25^\circ\text{C}$ ) - Derate above $25^\circ\text{C}$		$P_D$	45	W
			0.36	W/ $^\circ\text{C}$
Single Pulsed Avalanche Energy (Note 1)		$E_{AS}$	820	mJ
Operation Junction Temperature Rating		$T_J$	-55~+150	$^\circ\text{C}$
Storage Temperature Rating		$T_{stg}$	-55~+150	$^\circ\text{C}$

## THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.78	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C/W}$

## ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ , unless otherwise noted)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0\text{V}$ , $I_D=250\mu\text{A}$	650	--	--	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=650\text{V}$ , $V_{GS}=0\text{V}$	--	--	1.0	$\mu\text{A}$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 30\text{V}$ , $V_{DS}=0\text{V}$	--	--	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{GS}=V_{DS}$ , $I_D=250\mu\text{A}$	2.0	--	4.0	V
On State Resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}$ , $I_D=7.0\text{A}$	--	0.60	0.70	$\Omega$
Input Capacitance	$C_{iss}$	$V_{DS}=25\text{V}$ , $V_{GS}=0\text{V}$ , $f=1.0\text{MHz}$	--	1665.7	--	pF
Output Capacitance	$C_{oss}$		--	174.9	--	
Reverse Transfer Capacitance	$C_{rss}$		--	6.05	--	
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{DD}=325\text{V}$ , $I_D=11\text{A}$ , $R_G=24\Omega$ (Note 2,3)	--	27.52	--	ns
Turn-on Rise Time	$t_r$		--	40.20	--	
Turn-off Delay Time	$t_{d(\text{off})}$		--	91.84	--	
Turn-off Fall Time	$t_f$		--	40.44	--	
Total Gate Charge	$Q_g$	$V_{DS}=520\text{V}$ , $I_D=11\text{A}$ , $V_{GS}=10\text{V}$ (Note 2,3)	--	35.80	--	nC
Gate-Source Charge	$Q_{gs}$		--	11.80	--	
Gate-Drain Charge	$Q_{gd}$		--	12.14	--	



## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	$I_S$	Integral Reverse P-N Junction Diode in the MOSFET	--	--	11	A
Pulsed Source Current	$I_{SM}$		--	--	44	
Diode Forward Voltage	$V_{SD}$	$I_S=11A, V_{GS}=0V$	--	--	1.3	V
Reverse Recovery Time	$T_{rr}$	$I_S=11A, V_{GS}=0V,$ $dI_F/dt=100A/\mu s$ (Note 2)	--	541.47	--	ns
Reverse Recovery Charge	$Q_{rr}$		--	5.13	--	$\mu C$

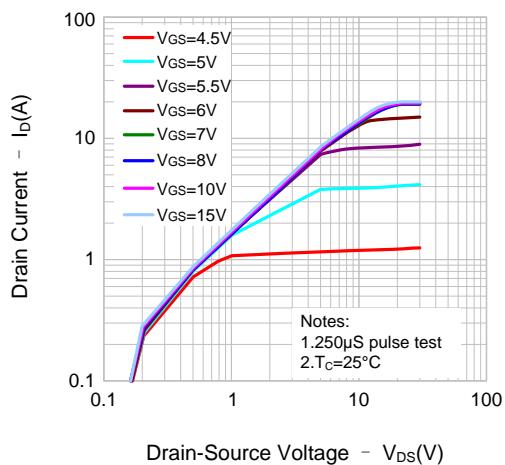
**Notes:**

1.  $L=30mH, I_{AS}=6.66A, V_{DD}=100V, R_G=25\Omega$ , starting  $T_J=25^\circ C$ ;
2. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ ;
3. Essentially independent of operating temperature.



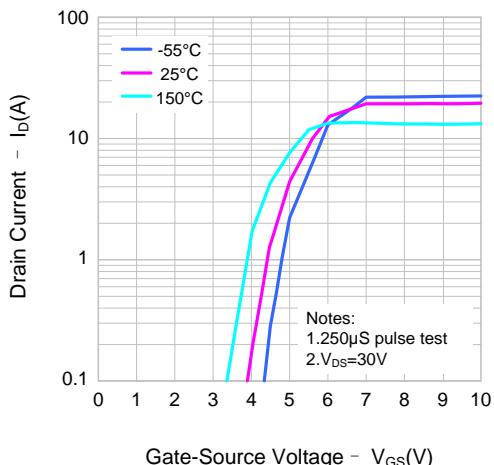
## TYPICAL CHARACTERISTICS

Figure 1. On-Region Characteristics



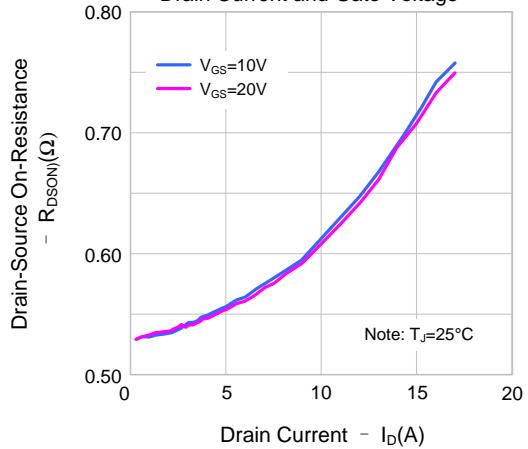
Drain-Source Voltage -  $V_{DS}(\text{V})$

Figure 2. Transfer Characteristics



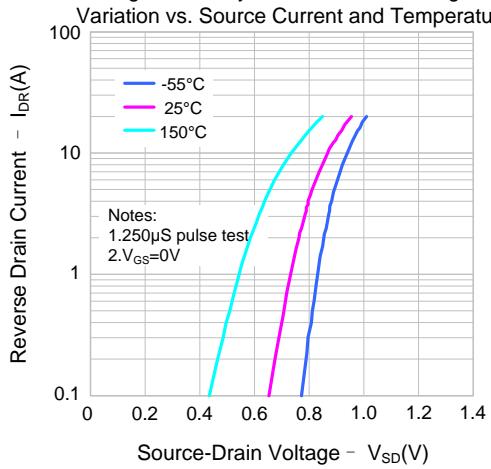
Gate-Source Voltage -  $V_{GS}(\text{V})$

Figure 3. On-Resistance Variation vs.  
Drain Current and Gate Voltage



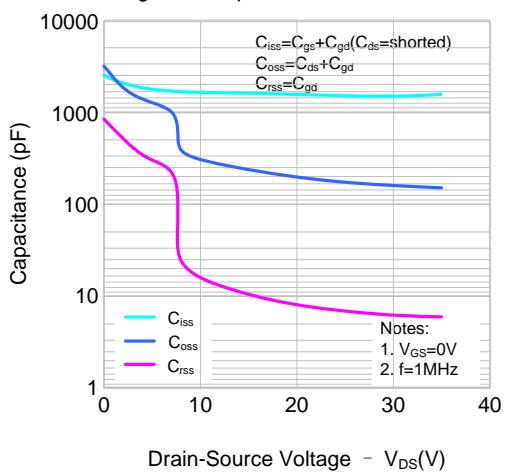
Drain Current -  $I_D(\text{A})$

Figure 4. Body Diode Forward Voltage  
Variation vs. Source Current and Temperature



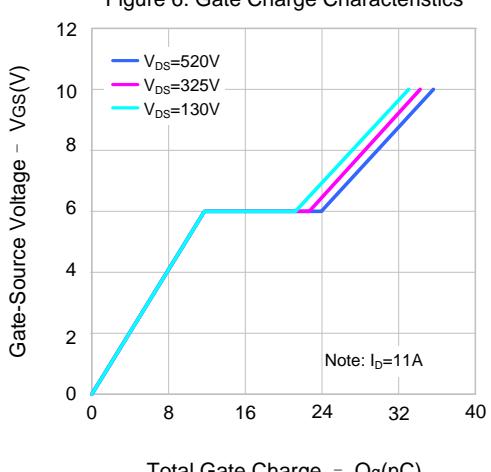
Source-Drain Voltage -  $V_{SD}(\text{V})$

Figure 5. Capacitance Characteristics



Drain-Source Voltage -  $V_{DS}(\text{V})$

Figure 6. Gate Charge Characteristics



Total Gate Charge -  $Q_g(\text{nC})$



## TYPICAL CHARACTERISTICS(continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

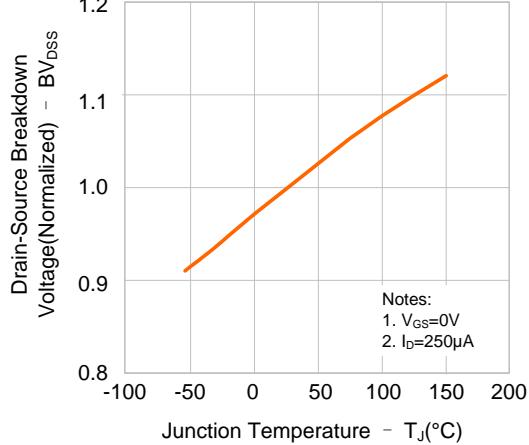


Figure 8. On-resistance Variation vs. Temperature

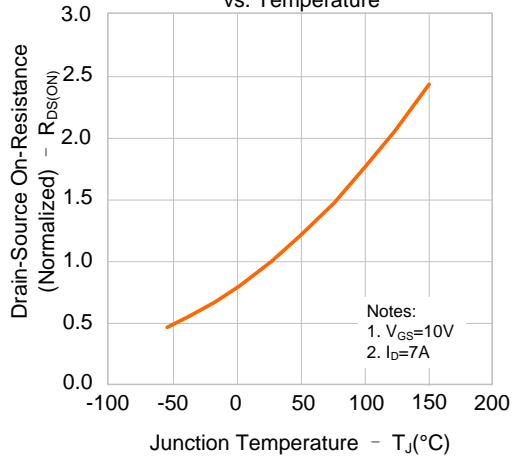


Figure 9. Max. Safe Operating Area

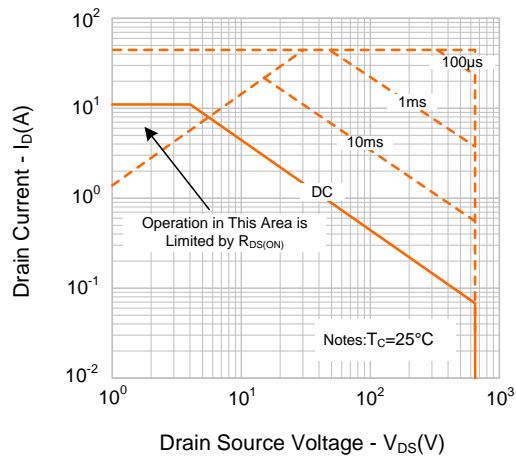
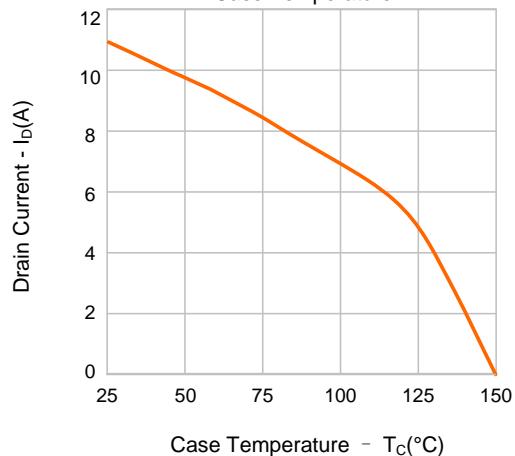


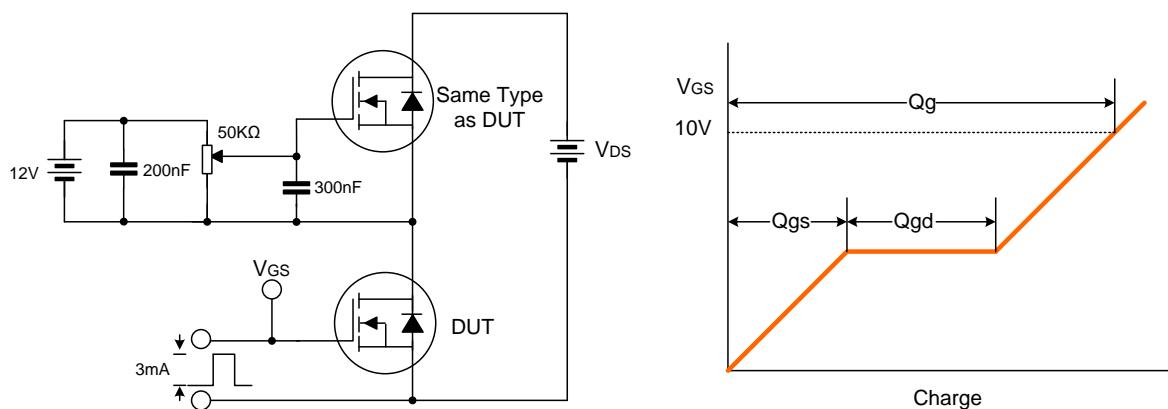
Figure 10. Maximum Drain Current vs. Case Temperature



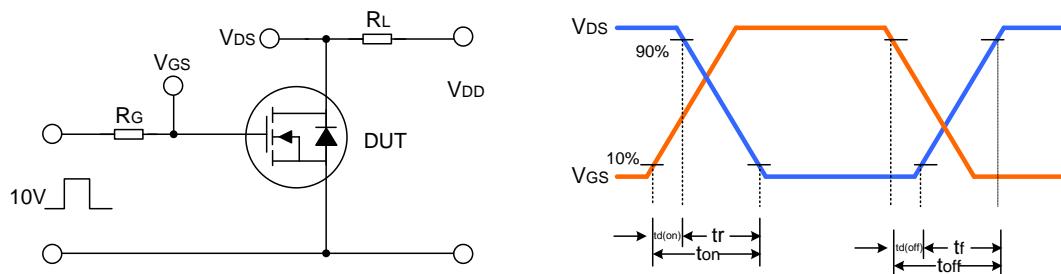


## TYPICAL TEST CIRCUIT

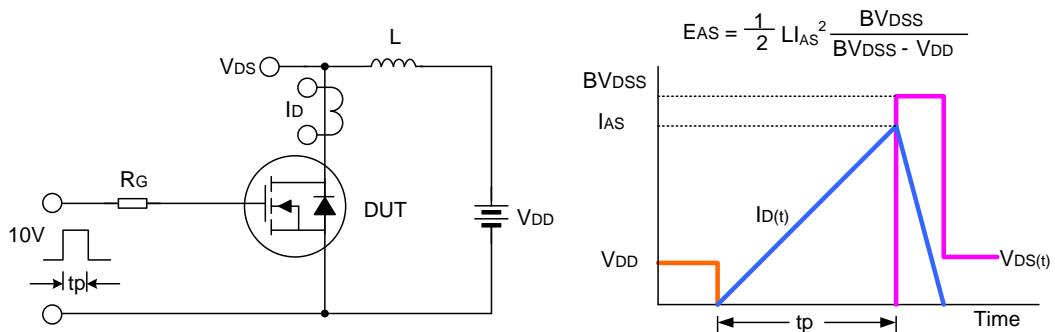
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform

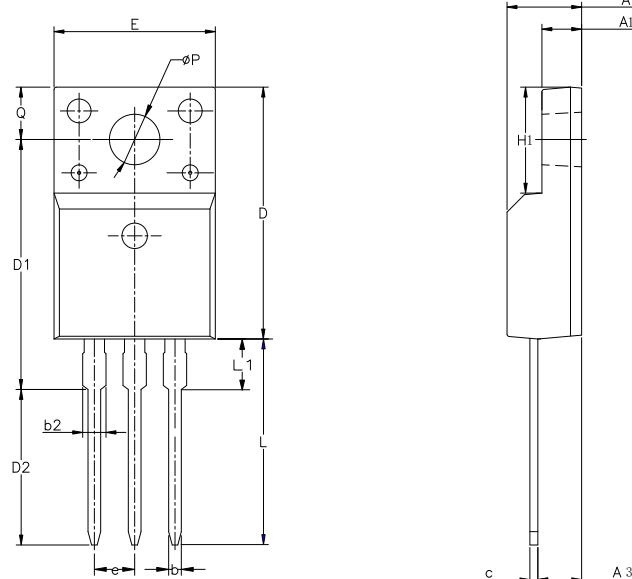




## PACKAGE OUTLINE

TO-220FJ-3L

UNIT: mm



SYMBOL	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.55	0.70	0.85
b2	—	—	1.29
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	13.97	14.47	14.97
D2	10.58	11.08	11.58
E	9.73	10.16	10.36
e	2.54BCS		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	2.00
ØP	3.00	3.18	3.40
Q	3.05	3.30	3.55

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# SVF11N65VFJ\_Datasheet

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Revision History:

1. Firsr release

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